

Ag-nanoplates decorated cavity-nanorod array SERS substrate for trace detection of PCB-77

Jinran Chen^{abc}, Xiurui Ke^{ac}, Zhou Zhou^d, Wen-Qi Ye^{*ac},
Hong Liu^{ac}, Wei Zhang^{ac}, Xiaohong Liu^{*e}

- a. Chongqing Institute of Green and Intelligent Technology, Chinese Academy of Sciences, Chongqing 400714, P. R. China
- b. Chongqing Jiaotong University, Chongqing, 400074, P. R. China
- c. Chongqing school, University of Chinese Academy of Sciences (UCAS Chongqing), Chongqing 400714, P. R. China
- d. The University of Manchester, Department of Materials, Oxford Road, Manchester M13 9PL UK
- e. National University of Singapore (Chongqing) Research Institute, Chongqing, 401123, P. R. China

* Corresponding Author: Wen-Qi Ye, E-mail: yewenqi@cigit.ac.cn; Xiaohong Liu, E-mail: xiaohong.liu@nusricq.cn

Table S1 Orthogonal test of MACE

Sequence	Factor	Concentration of AgNO ₃ (mol • L ⁻¹)	Deposition Time (min)	Etching Time (min)
1		5.0×10 ⁻³	2	3
2		5.0×10 ⁻³	3	4
3		5.0×10 ⁻³	4	5
4		7.5×10 ⁻³	2	4
5		7.5×10 ⁻³	3	5
6		7.5×10 ⁻³	4	3
7		10×10 ⁻³	2	5
8		10×10 ⁻³	3	3
9		10×10 ⁻³	4	4

Table S2 Analyze orthogonal test

Project	Level	Concentration of AgNO ₃ (mol·L ⁻¹)	Deposition Time (min)	Etching Time (min)
K	1	24951.06	-	-
	2	14175.97	-	13789.19
	3	15619.81	19333.31	22576.27
	4	-	18135.31	18381.37
	5	-	17278.22	-
K _{avg}	1	8317.02	-	-
	2	4725.32	-	4596.4
	3	5206.6	6444.44	7525.42
	4	-	6045.1	6127.12
	5	-	5759.41	-
The best level		1	3	3
R		3591.7	685.03	2929.03
Quantity		3	3	3
Repeats		3	3	3

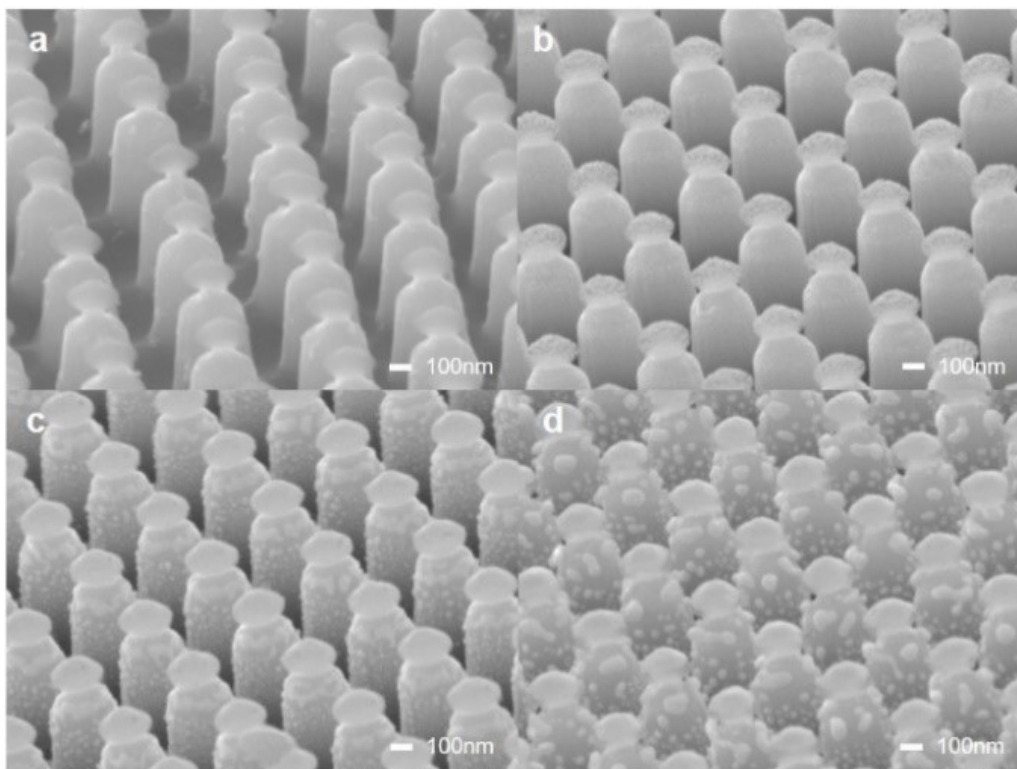


Figure S1 SEM images of sputtering (a) 0 nm, (b) 5 nm, (c) 10 nm, (d) 15nm Au on nanorod substrate.

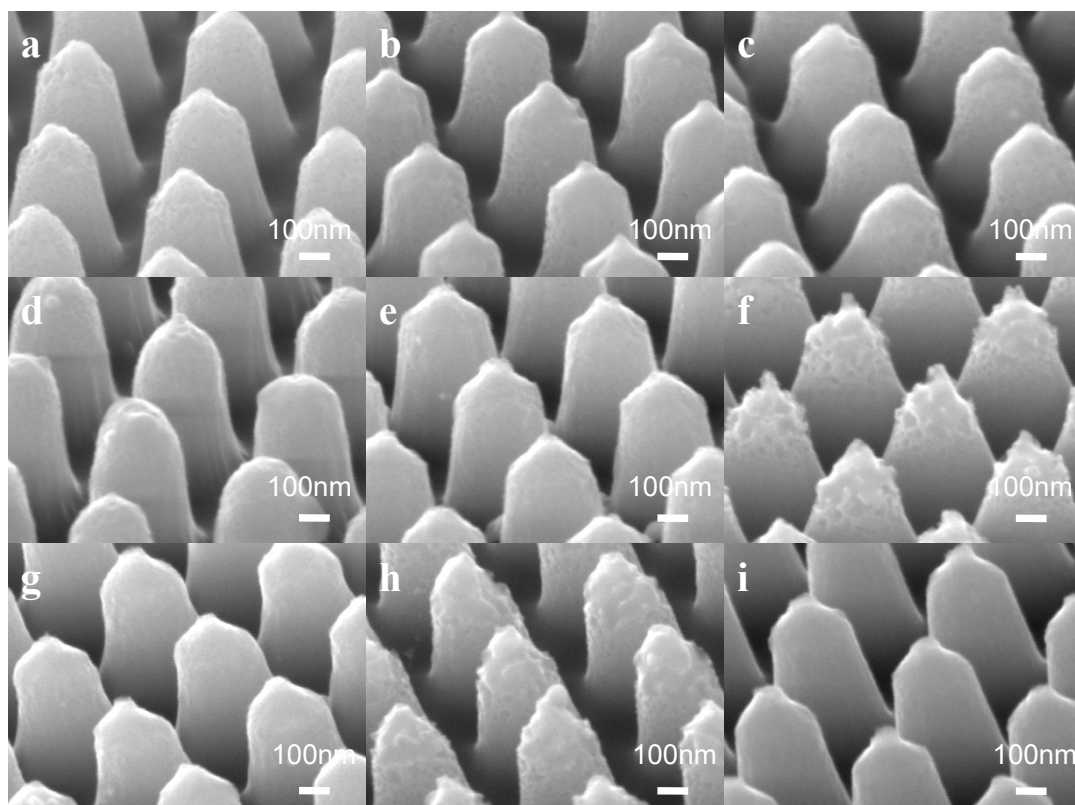


Figure S2 SEM images of substrate (a)~(i) No.1~9 in orthogonal test.

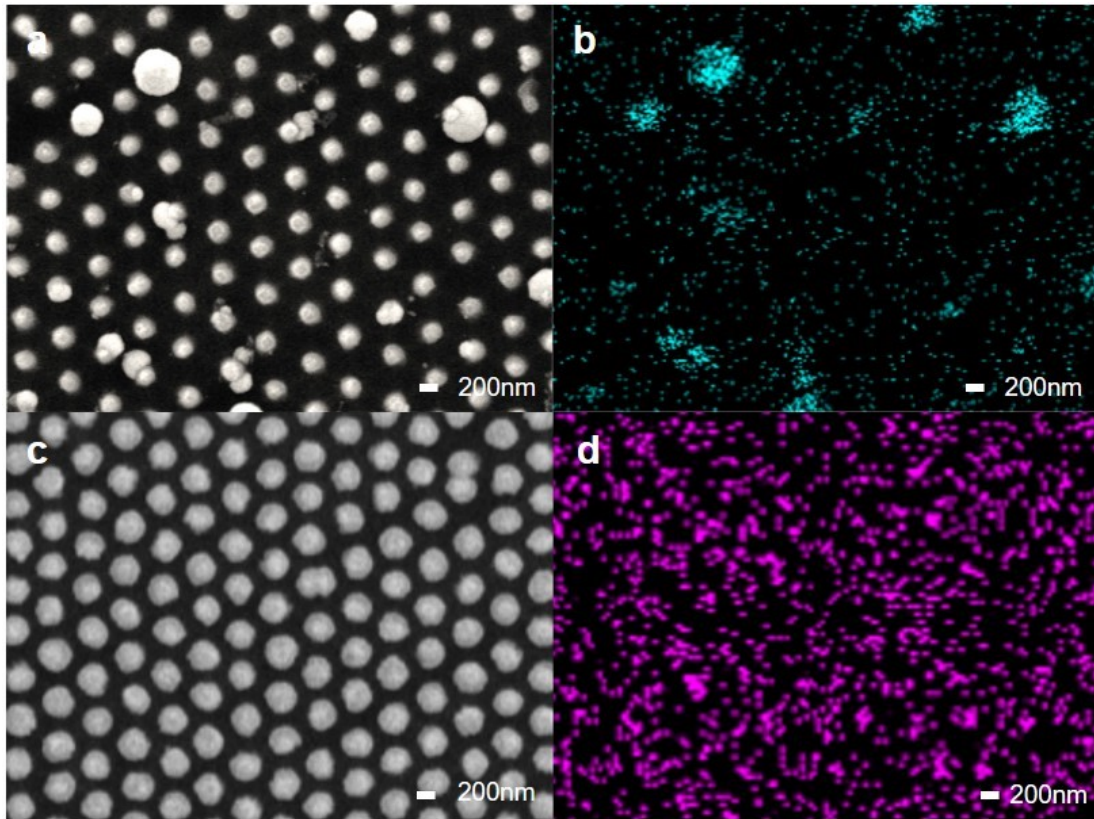


Figure S3 The substrate without gold seeds was deposited in galvanic cell at 10min: (a) SEM image, (b) Ag in EDS mapping; the substrate with gold seeds was deposited in galvanic cell at 10min: (c) SEM image, (d) Ag in EDS mapping.

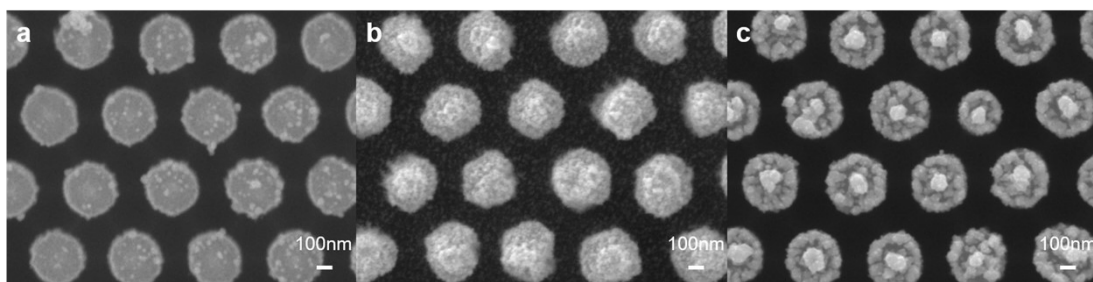


Figure S4 SEM images of No.8 substrates deposit in galvanic cells for (a) 5 min, (b) 10 min, and (c) 15 min.

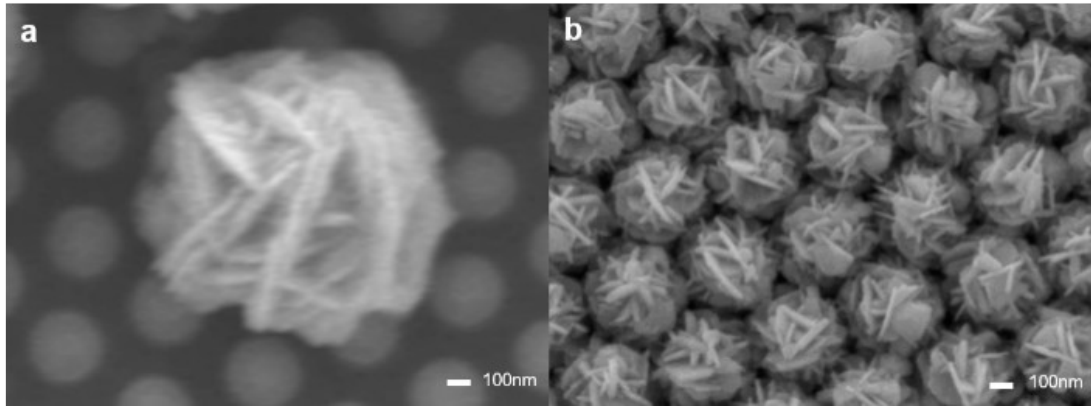


Figure S5 The gold-sputtered substrate and the nongold-sputtered substrate galvanic cells were deposited for 20min.

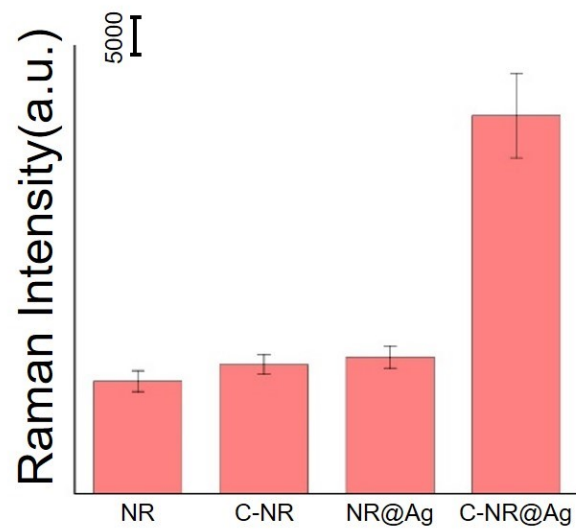


Figure S6 The performance of different substrates using the characteristic peak intensity of 611 cm^{-1} based on the Raman spectra. The error bar was calculated by three replicated determinations.

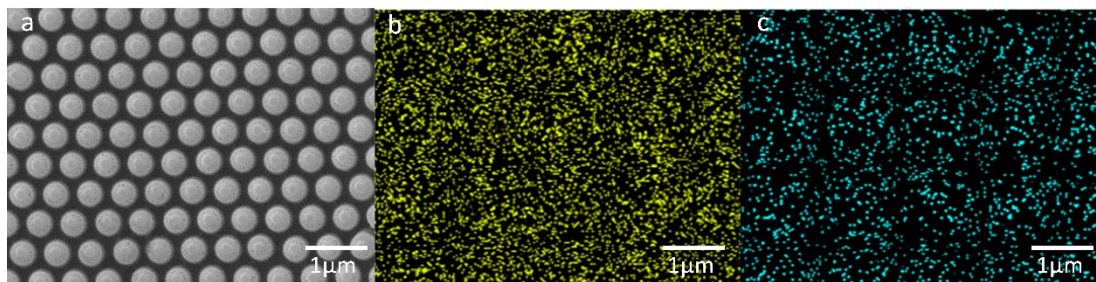


Figure S7 (a) SEM image of C-NR@Ag substrate. (b) EDS mapping results of Au on C-NR@Ag substrate based on a. (c) EDS mapping results of Ag on C-NR@Ag substrate based on a.

Table S3 EDS content analysis of various elements on the surface

element	Normalized quality (%)	Atom (%)
C	6.76	16.90
O	1.04	1.94
Si	71.94	76.88
Ag	9.44	2.63
Au	10.82	1.65
Total	100.00	100.00

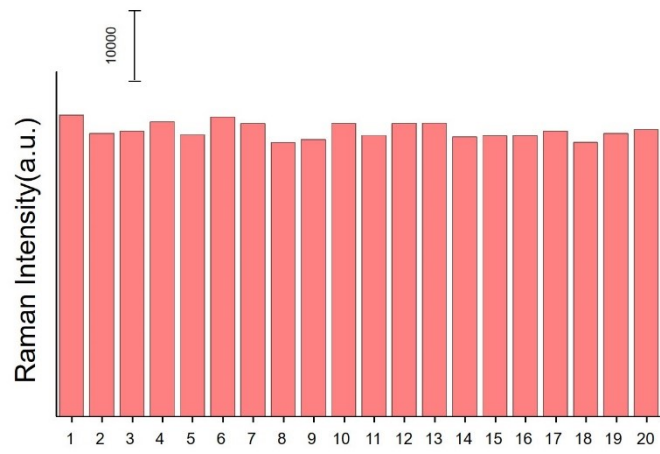


Figure S8 20 points of the peak intensity of 1078 cm^{-1} .

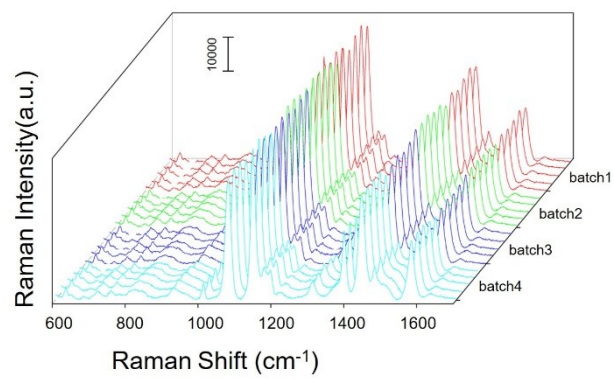


Figure S9 The Raman spectra of the substrate with four batches using 10^{-5} M p-ATP.

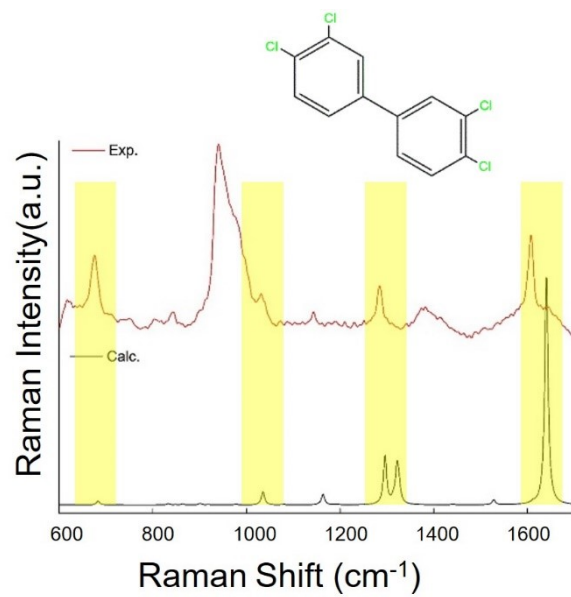


Figure S10 The Raman peak positions of the PCB-77 molecules from theoretical simulation from 650 cm^{-1} to 1650 cm^{-1} .

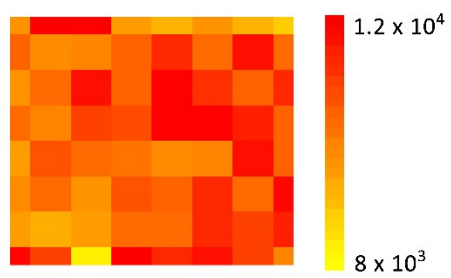


Figure S11 The uniformity of the substrate using the characteristic peak intensity of 1608 cm⁻¹.